

Single N-channel MOSFET

ELM16408EA-S

General description

ELM16408EA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and operation with gate voltages as low as 1.8V and internal ESD protection is included.

Features

- $V_{ds}=20V$
- $I_d=8.8A$ ($V_{gs}=10V$)
- $R_{ds(on)} < 18m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 20m\Omega$ ($V_{gs}=4.5V$)
- $R_{ds(on)} < 25m\Omega$ ($V_{gs}=2.5V$)
- $R_{ds(on)} < 32m\Omega$ ($V_{gs}=1.8V$)
- ESD Rating : 2000V HBM

Maximum absolute ratings

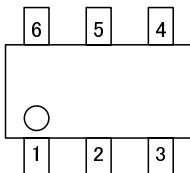
Parameter		Symbol	Limit	Unit	Note
Drain-source voltage		V_{ds}	20	V	
Gate-source voltage		V_{gs}	± 12	V	
Continuous drain current	$T_a=25^\circ C$	I_d	8.8	A	1
	$T_a=70^\circ C$		7.0		
Pulsed drain current		I_{dm}	40	A	2
Power dissipation	$T_a=25^\circ C$	P_d	2.00	W	
	$T_a=70^\circ C$		1.28		
Junction and storage temperature range		T_j, T_{stg}	-55 to 150	$^\circ C$	

Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R\theta_{ja}$	47.5	62.5	$^\circ C/W$	1
Maximum junction-to-ambient	Steady-state		74.0	110.0	$^\circ C/W$	
Maximum junction-to-lead	Steady-state	$R\theta_{jl}$	37.0	40.0	$^\circ C/W$	3

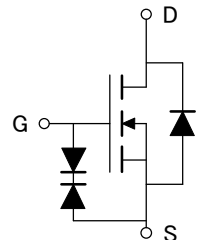
Pin configuration

SOT-26 (TOP VIEW)



Pin No.	Pin name
1	DRAIN
2	DRAIN
3	GATE
4	SOURCE
5	DRAIN
6	DRAIN

Circuit



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Electrical characteristics

Ta=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BVdss	Id=250 μ A, Vgs=0V	20			V
Zero gate voltage drain current	Idss	Vds=16V Vgs=0V			10	μ A
		Tj=55°C			25	
Gate-body leakage current	Igss	Vds=0V, Vgs= $\pm$ 10V			$\pm$ 10	μ A
Gate-source breakdown voltage	BVgso	Vds=0V, Ig= $\pm$ 250 μ A	$\pm$ 12			V
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250 μ A	0.50	0.75	1.00	V
On state drain current	Id(on)	Vgs=4.5V, Vds=5V	40			A
Static drain-source on-resistance	Rds(on)	Vgs=10V Id=8.8A		14.4	18.0	m Ω
		Tj=125°C		18.5	23.0	
		Vgs=4.5V, Id=8A		16.0	20.0	m Ω
		Vgs=2.5V, Id=6A		20.5	25.0	m Ω
		Vgs=1.8V, Id=4A		25.6	32.0	m Ω
Forward transconductance	Gfs	Vds=5V, Id=8.8A		33		S
Diode forward voltage	Vsd	Is=1A		0.72	1.00	V
Max. body-diode continuous current	Is				3	A
DYNAMIC PARAMETERS						
Input capacitance	Ciss	Vgs=0V, Vds=10V, f=1MHz		1810	2200	pF
Output capacitance	Coss			232		pF
Reverse transfer capacitance	Crss			200		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		1.6	2.2	Ω
SWITCHING PARAMETERS						
Total gate charge	Qg	Vgs=4.5V, Vds=10V, Id=8.8A		17.9	22.0	nC
Gate-source charge	Qgs			1.5		nC
Gate-drain charge	Qgd			4.7		nC
Turn-on delay time	td(on)	Vgs=10V, Vds=10V Rl=1.1 Ω , Rgen=3 Ω		3.3		ns
Turn-on rise time	tr			5.9		ns
Turn-off delay time	td(off)			44.0		ns
Turn-off fall time	tf			7.7		ns
Body diode reverse recovery time	trr	If=8.8A, dI/dt=100A/ μ s		22.0	27.0	ns
Body diode reverse recovery charge	Qrr	If=8.8A, dI/dt=100A/ μ s		9.8		nC

NOTE :

1. The value of R θ ja is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with Ta=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t $\leq$ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R θ ja is the sum of the thermal impedance from junction to lead R θ jl and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 μ s pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with Ta=25°C. The SOA curve provides a single pulse rating.

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Typical electrical and thermal characteristics

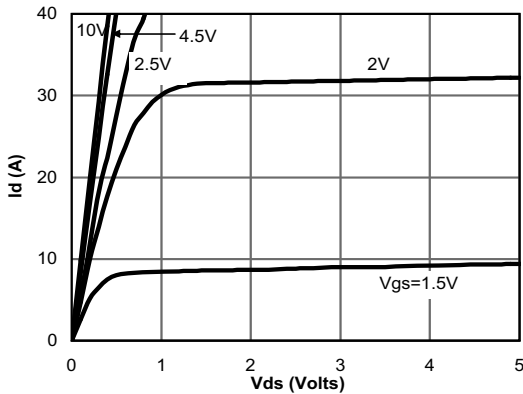


Fig 1: On-Region Characteristics

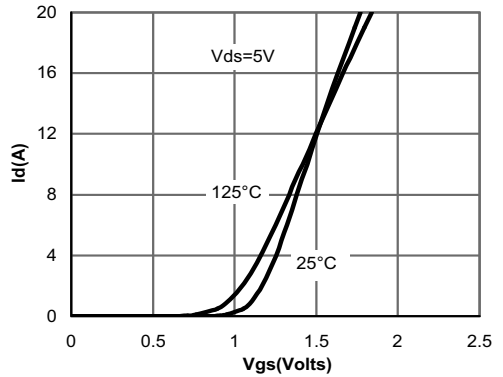


Figure 2: Transfer Characteristics

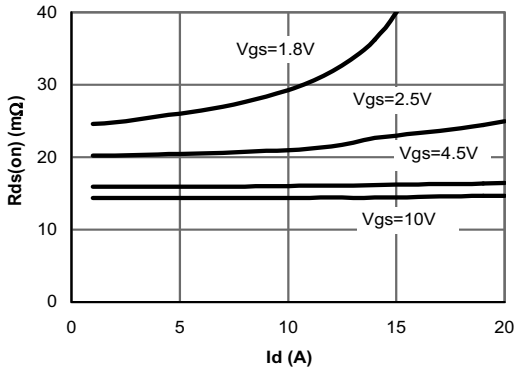


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

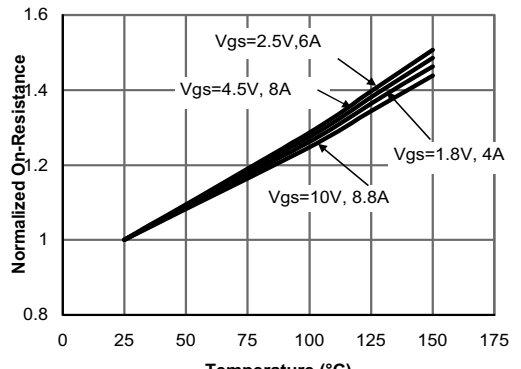


Figure 4: On-Resistance vs. Junction Temperature

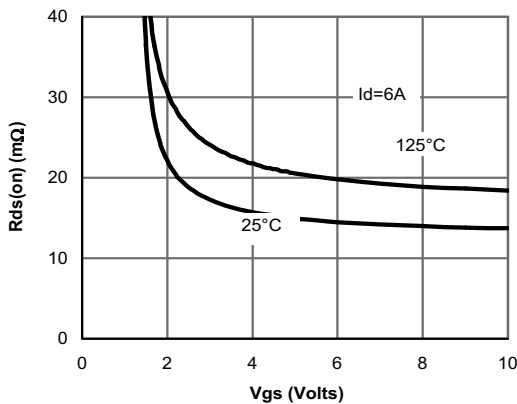


Figure 5: On-Resistance vs. Gate-Source Voltage

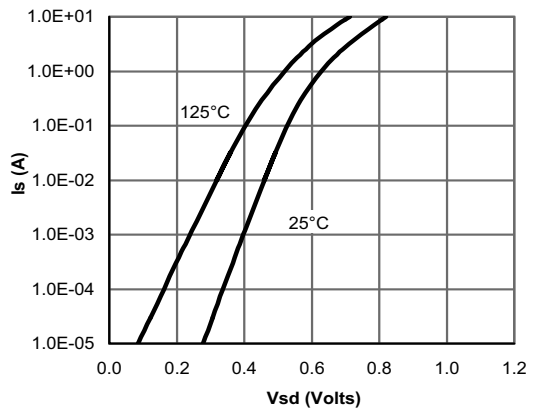


Figure 6: Body-Diode Characteristics

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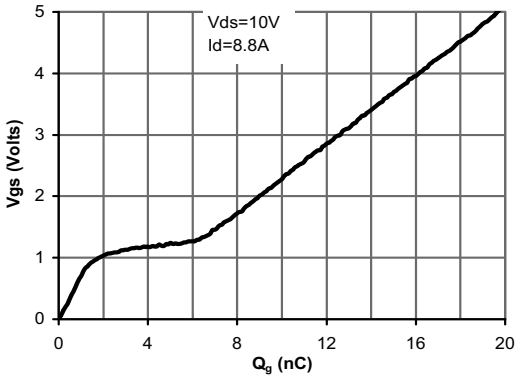


Figure 7: Gate-Charge Characteristics

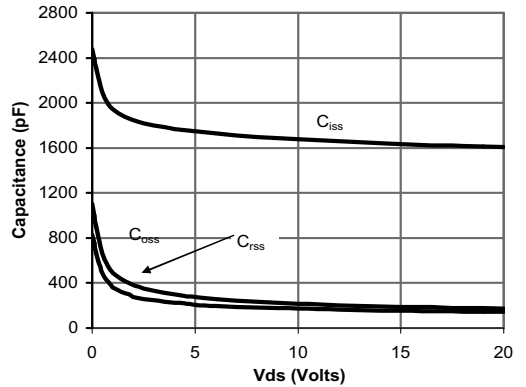


Figure 8: Capacitance Characteristics

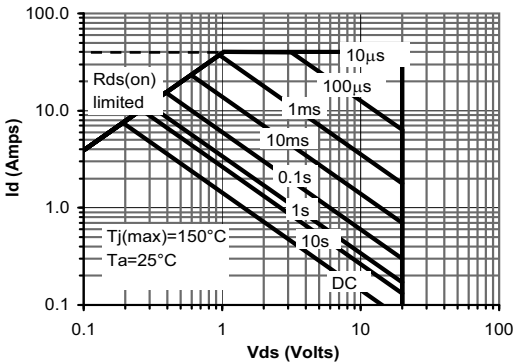


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

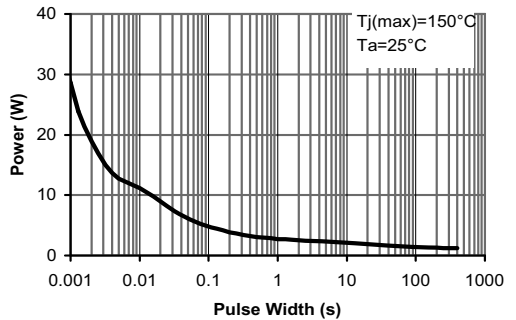


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

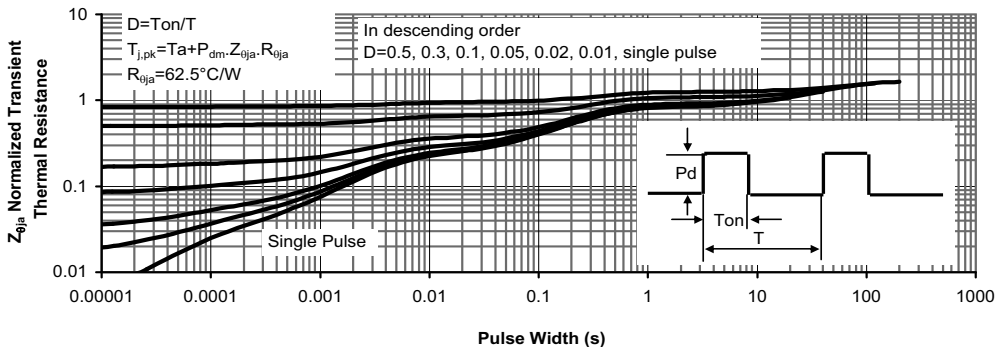


Figure 11: Normalized Maximum Transient Thermal Impedance